Ceramic

Bandpass Filter

BFCN-5200AT+

 50Ω 4250 to 6300 MHz

The Big Deal

- LTCC construction
- Temperature stable from -40 to +105°C
- Small size (0.126 x .063 X .037")
- AEC-Q200 qualified component family



CASE STYLE: FV1206-4

Product Overview

The BFCN-5200AT+ LTCC bandpass filter covers the 4250 to 6300 MHz passband with 1.8 dB passband insertion loss, 23 dB lower stopband rejection, and 21 dB upper stopband rejection. This model handles up to 2.5W RF input power and provides a wide operating temperature range from -40 to +105°C. Utilizing LTCC multilayer construction, the filter achieves excellent repeatability of performance and comes in a tiny 1206 ceramic package with wraparound terminations, minimizing performance variations due to parasitics and saving space in dense PCB layouts.

Key Features

Feature	Advantages	
LTCC Construction	Provides a rugged package well suited for tough environments such as high humidity and temperature extremes.	
Tiny size (0.126 x .063 x .037")	Saves space in dense circuit boards and minimizes the effects of parasitics.	
Wrap-around terminations	Provides excellent solderability and easy visual inspection	
Wide operating temperature range, -40 to +105°C	Enables reliable performance in extreme environments	

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Features

• Small size(0.126 x .063 x .037)

Specification Definition

- Temperature stable
- LTCC construction
- · AEC-Q200 qualified component family

Applications

Automotive

NSERTION LOSS (dB)

BFCN-5200AT+



Generic photo used for illustration purposes only

CASE STYLE: FV1206-4

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



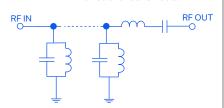
Electrical Specifications^{1,2} at +25°C

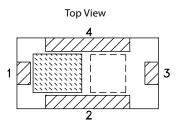
Para	meter	F#	Frequency (MHz) Min. Typ. M		Max.	Unit	
	Center Frequency	_			5200		MHz
Pass Band	Insertion Loss	F1 - F2	4250 - 6300	_	1.8	3.5	dB
	VSWR		4250 - 6300	_	2.3	_	:1
Chair Daniel Lauren	Insertion Loss		3300	15	23	_	dB
Stop Band, Lower VSWR		DC - F3	3300	_	23	_	:1
Stan Band Haner Insertion Loss		F4 - F5	7500 - 9000	10	21	_	dB
Stop Band, Upper	VSWR	F4 - F5	7500 - 9000	_	16	_	:1

- 1. Measured on Mini-Circuits Characterization Test Board TB-824+ using BFCN-5200+.
 2. This filter is not intended for use as a DC Blocking circuit element. In Application where DC voltage is present at either input or output ports, blocking

Functional Schematic

FREQUENCY (MHz)





Pad Connections

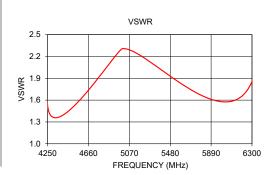
Input	1
Output	3
Ground	2.4

Maximum Ratings

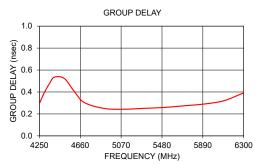
Operating Temperature	-40°C to +105°C			
Storage Temperature	-40°C to +105°C			
RF Power Input*	2.5 W at +25°C			

*Passband rating, derate linearly to 0.7 W at +105°C ambient Permanent damage may occur if any of these limits are exceeded.









Full Band Performance

Pass Band Performance

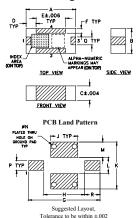
Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)	Frequency (MHz)	Insertion Loss (dB)	Group Delay (nsec)
100	72.07	130.26	4250	1.52	0.29
300	53.80	99.00	4300	1.45	0.40
500	45.22	82.81	4350	1.44	0.48
1000	34.09	67.56	4400	1.47	0.54
1600	26.73	59.04	4500	1.56	0.52
2000	23.26	53.49	4600	1.66	0.41
2600	20.06	44.34	4700	1.75	0.30
3000	21.09	37.90	4900	1.85	0.25
3500	22.24	23.85	5100	1.84	0.24
4250	1.52	1.52	5300	1.81	0.25
5000	1.86	2.31	5500	1.79	0.26
6300	2.14	1.86	5700	1.83	0.27
7200	14.79	9.49	5900	1.90	0.29
8000	25.38	23.09	6100	1.98	0.32
9000	15.15	18.38	6300	2.14	0.39

Pad Connections

Input	1
Output	3
Ground	2,4

Product Marking: GC

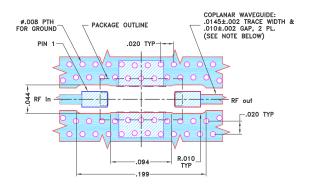
Outline Drawing



Outline Dimensions (inch mm)

J	Н	G	F	E	D	С	В	Α
.069	.104	.182	.012	.075	.026	.037	.063	.126
1.75	2.64	4.62	0.30	1.91	0.66	0.94	1.60	3.20
wt		R	Q	Р	N	М	L	K
grams		.039	.020	.024	.013	.039	.041	.119
.020		0.99	0.51	0.61	0.33	0.99	1.04	3.02

Demo Board MCL P/N: TB-824+ Suggested PCB Layout (PL-454)



- INTEGE WIDTH PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .0066"±.0007". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED. 2. BOTTOM SIDE OF THE PCB IS CONTIN
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER). DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp